

### General Description

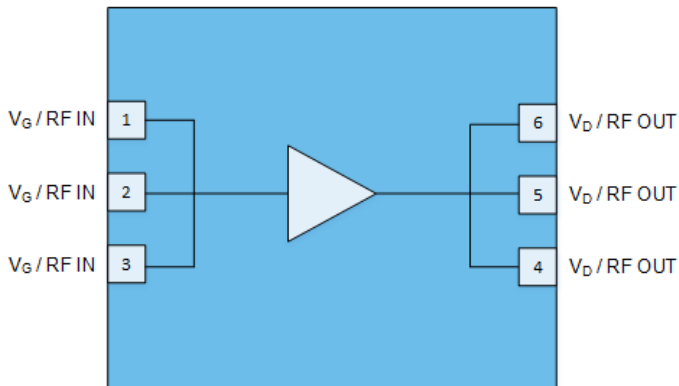
The Qorvo QPD1013 is a 150 W ( $P_{3dB}$ ) discrete GaN on SiC HEMT which operates from DC to 2.7 GHz. This is a single stage unmatched power amplifier transistor in an over-molded plastic package. The high power and wide bandwidth of the QPD1013 makes it suitable for many different applications from DC to 2.7 GHz.

The device is housed in an industry-standard 7.2 x 6.6 mm surface mount DFN package.

Lead-free and ROHS compliant

Evaluation boards are available upon request.

### Functional Block Diagram



6 Pin DFN (7.2 x 6.6 x 0.9 mm)

### Product Features

- Frequency: DC to 2.7 GHz
  - Output Power ( $P_{3dB}$ ): 178 W<sup>1</sup>
  - Linear Gain: 21.8 dB<sup>1</sup>
  - Typical PAE<sub>3dB</sub>: 64.8 %<sup>1</sup>
  - Operating Voltage: 65 V
  - Low thermal resistance package
  - CW and Pulse capable
  - 7.2 x 6.6 mm package
- Note 1: @ 1.8 GHz (Loadpull)

### Applications

- Military radar
- Land mobile and military radio communications
- Test instrumentation
- Wideband or narrowband amplifiers
- Jammers

### Ordering info

Part No.	ECCN	Description
QPD1013S2	EAR99	2 Piece Sample Bag
QPD1013SQ	EAR99	25 Piece Sample Bag
QPD1013SR	EAR99	100 Piece 7" Reel
QPD1013EVB01	EAR99	1.2 – 1.9 GHz EVB

## Absolute Maximum Ratings<sup>2</sup>

Parameter	Rating	Units
Breakdown Voltage, $BV_{DG}$	225	V
Gate Voltage Range, $V_G$	-8 to +2	V
Drain Current, $I_D$	9	A
Gate Current Range, $I_G^1$	19.2	mA
Power Dissipation, CW, $P_{DISS}$	74	W
RF Input Power at 1.6 GHz, CW, 50 $\Omega$ , T = 25 °C	+39	dBm
Channel Temperature, $T_{CH}$	275	°C
Mounting Temperature (30 Seconds)	320	°C
Storage Temperature	-65 to +150	°C

Notes:

1. At Channel temperature of 200°C.
2. Operation of this device outside the parameter ranges given above may cause permanent damage.

## Recommended Operating Conditions<sup>1</sup>

Parameter	Min	Typ	Max	Units
Operating Temp. Range	-40	+25	+85	°C
Drain Voltage Range, $V_D$	–	+65	+70	V
Drain Bias Current, $I_{DQ}$	–	240	–	mA
Drain Current, $I_D$	–	1.7	–	A
Gate Voltage, $V_G^4$	–	-2.8	–	V
Channel Temperature ( $T_{CH}$ )	–	–	250	°C
Power Dissipation, CW ( $P_D$ ) <sup>2</sup>	–	–	67.0	W
Power Dissipation, Pulsed ( $P_D$ ) <sup>2, 3</sup>	–	–	120.0	W

Notes:

1. Electrical performance is measured under conditions noted in the electrical specifications table. Specifications are not guaranteed over all recommended operating conditions.
2. Back plane of package at 85 °C
3. Pulse Width = 100  $\mu$ s, Duty Cycle = 10%
4. To be adjusted to desired  $I_{DQ}$

**Pulsed Characterization – Load Pull Performance – Power Tuned – 65 V<sup>1</sup>**

Parameters	Typical Values					Unit
Frequency, F	1.2	1.5	1.8	2.3	2.7	GHz
Linear Gain, G <sub>LIN</sub>	23.7	22.3	20.3	18.1	15.2	dB
Output Power at 3dB compression point, P <sub>3dB</sub>	52.7	52.5	52.5	52.3	52.1	dBm
Power-Added-Efficiency at 3dB compression point, PAE <sub>3dB</sub>	61.5	58.1	53.7	51.1	43.2	%
Gain at 3dB compression point	20.7	19.3	17.3	15.1	12.2	dB

Notes:

1. Test conditions unless otherwise noted: V<sub>D</sub> = +65 V, I<sub>DQ</sub> = 240 mA, Temp = +25 °C

**Pulsed Characterization – Load Pull Performance – Efficiency Tuned – 65 V<sup>1</sup>**

Parameters	Typical Values					Unit
Frequency	1.2	1.5	1.8	2.3	2.7	GHz
Linear Gain, G <sub>LIN</sub>	25.3	23.7	21.8	19.3	16.8	dB
Output Power at 3dB compression point, P <sub>3dB</sub>	50.6	50.2	51.1	51.1	50.9	dBm
Power-Added-Efficiency at 3dB compression point, PAE <sub>3dB</sub>	70.9	69.4	64.8	57.5	52.3	%
Gain at 3dB compression point	22.3	20.7	18.8	16.3	13.8	dB

Notes:

- 1- Test conditions unless otherwise noted: V<sub>D</sub> = +65 V, I<sub>DQ</sub> = 240 mA, Temp = +25 °C

**Pulsed Characterization – Load Pull Performance – Power Tuned – 50 V<sup>1</sup>**

Parameters	Typical Values					Unit
Frequency, F	1.2	1.5	1.8	2.7		GHz
Linear Gain, G <sub>LIN</sub>	22.5	21.9	19.7	15.2		dB
Output Power at 3dB compression point, P <sub>3dB</sub>	51.5	51.5	51.6	51.4		dBm
Power-Added-Efficiency at 3dB compression point, PAE <sub>3dB</sub>	62.8	56.8	50.5	50.9		%
Gain at 3dB compression point	19.5	18.9	16.7	12.2		dB

Notes:

1. Test conditions unless otherwise noted: V<sub>D</sub> = +50 V, I<sub>DQ</sub> = 240 mA, Temp = +25 °C

**Pulsed Characterization – Load Pull Performance – Efficiency Tuned – 50 V<sup>1</sup>**

Parameters	Typical Values					Unit
Frequency, F	1.2	1.5	1.8	2.7		GHz
Linear Gain, G <sub>LIN</sub>	23.7	23.3	21.0	16.2		dB
Output Power at 3dB compression point, P <sub>3dB</sub>	49.9	50.4	49.6	50.8		dBm
Power-Added-Efficiency at 3dB compression point, PAE <sub>3dB</sub>	73.1	67.7	64.6	58.1		%
Gain at 3dB compression point	20.7	20.3	18.0	13.2		dB

Notes:

1. Test conditions unless otherwise noted: V<sub>D</sub> = +50 V, I<sub>DQ</sub> = 240 mA, Temp = +25 °C

**RF Characterization – 1.2 – 1.9 GHz EVB Performance At 1.6 GHz<sup>1</sup>**

Parameter	Min	Typ	Max	Units
Linear Gain, $G_{LIN}$	–	16.6	–	dB
Output Power at 3dB compression point, $P_{3dB}$	–	51.9	–	dBm
Drain Efficiency at 3dB compression point, $DEFF_{3dB}$	–	55.3	–	%
Gain at 3dB compression point, $G_{3dB}$	–	13.6	–	dB

Notes:

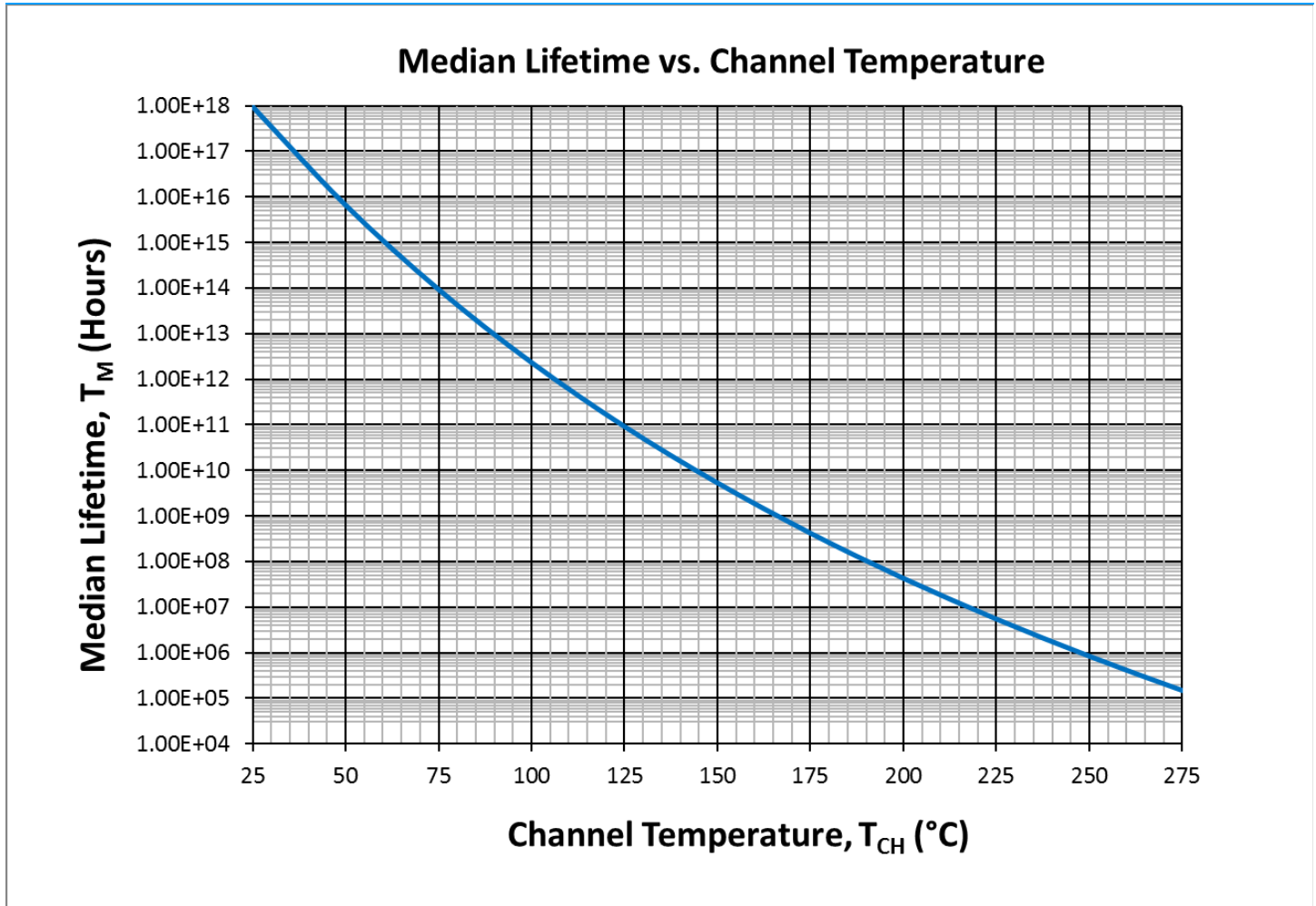
1.  $V_D = +65\text{ V}$ ,  $I_{DQ} = 240\text{ mA}$ , Temp =  $+25\text{ }^\circ\text{C}$ , Pulse Width = 100 us, Duty Cycle = 10%

**RF Characterization – Mismatch Ruggedness at 1.6 GHz<sup>1,2</sup>**

Symbol	Parameter	dB Compression	Typical
VSWR	Impedance Mismatch Ruggedness	3	10:1

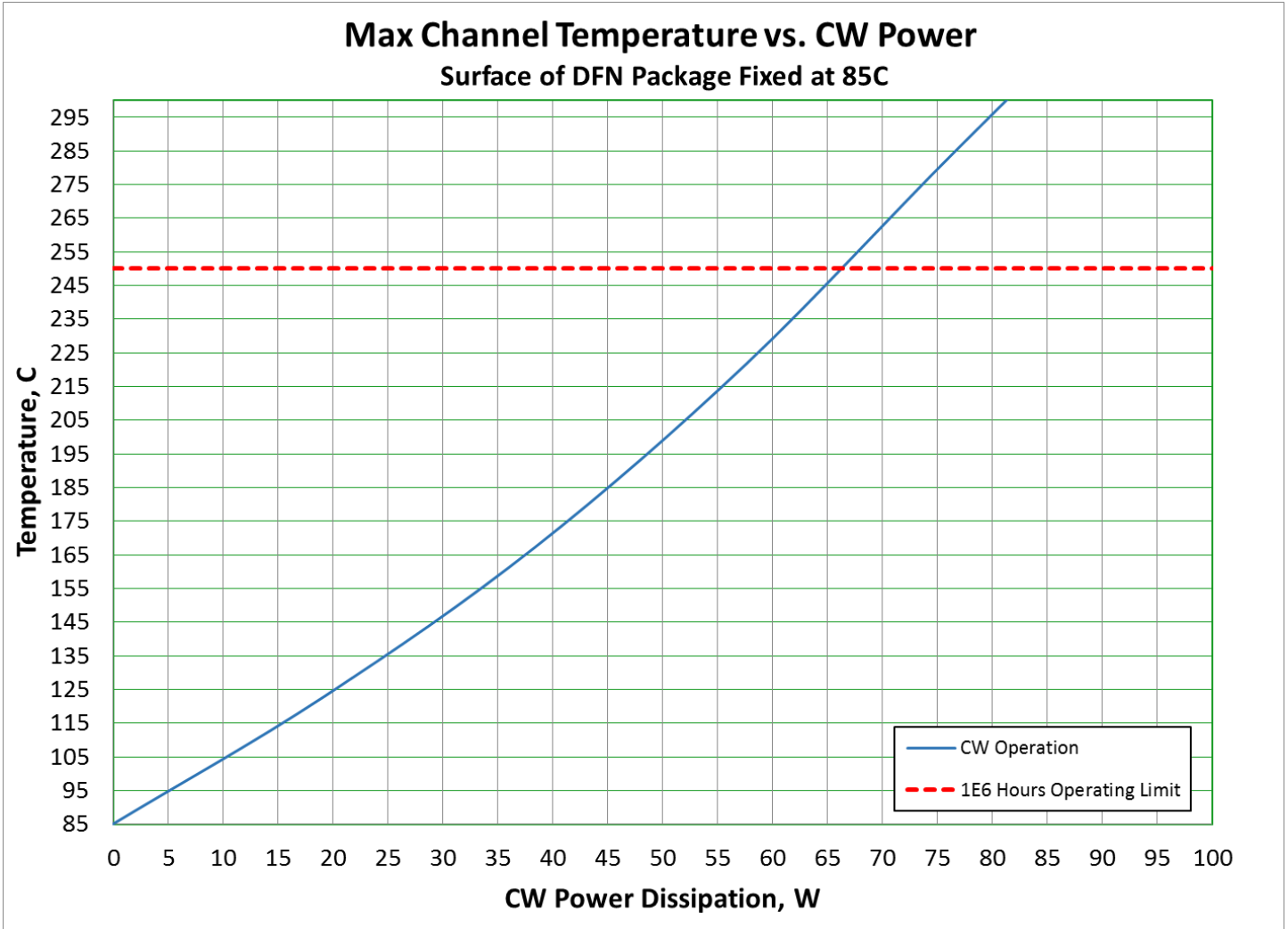
Notes:

- 1- Test conditions unless otherwise noted:  $T_A = 25\text{ }^\circ\text{C}$ ,  $V_D = 65\text{ V}$ ,  $I_{DQ} = 240\text{ mA}$
- 2- Driving input power is determined at pulsed compression under matched condition at EVB output connector.

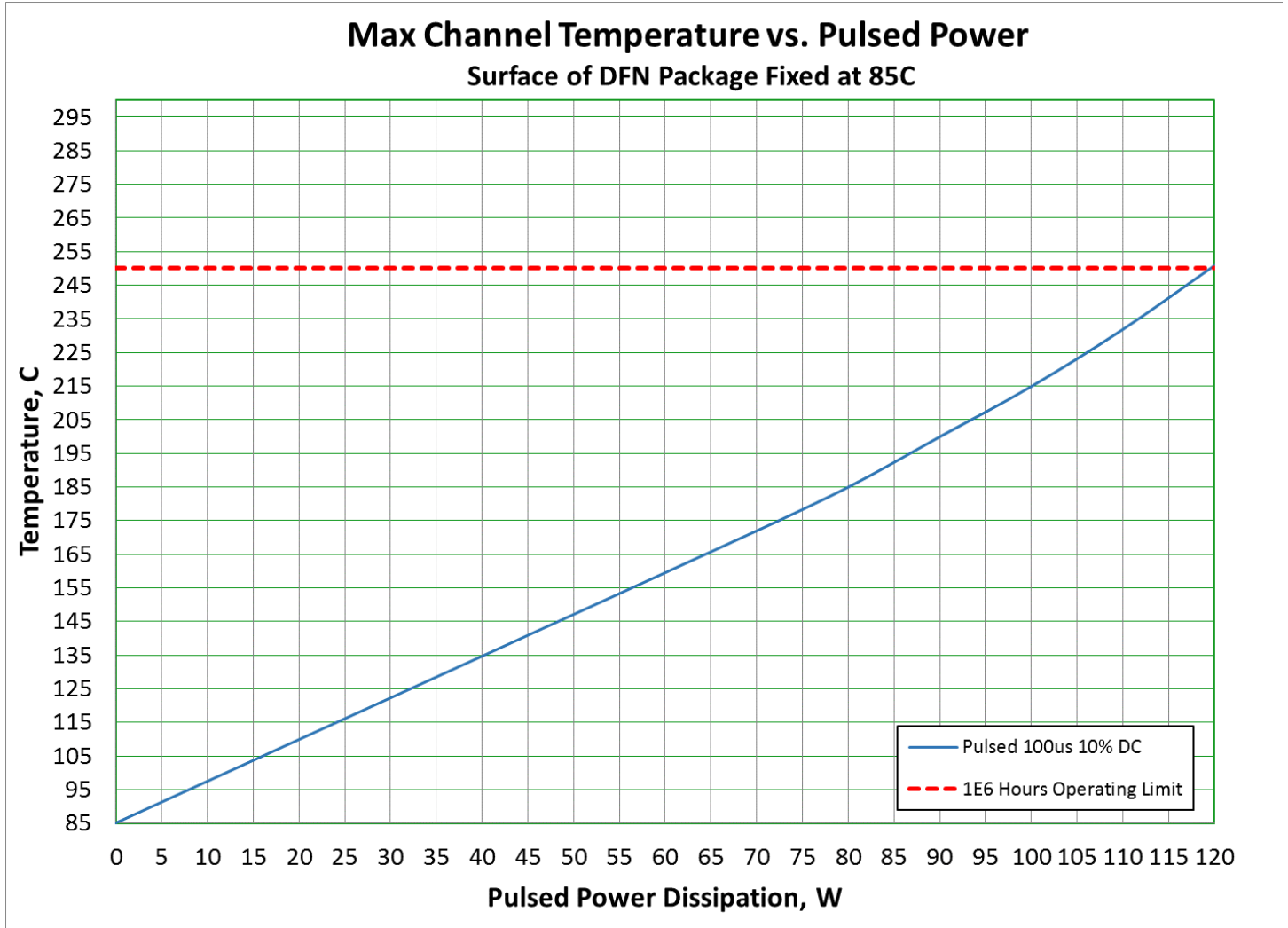
**Median Lifetime<sup>1</sup>****Notes:**

- 1- For pulsed signals, average lifetime is average lifetime at maximum channel temperature divided by duty cycle.

**Thermal and Reliability Information - CW**



Parameter	Conditions	Values	Units
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	2.0	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	19.2 W Pdiss, CW	124	°C
Median Lifetime ( $T_M$ )		9.0E10	Hrs
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	2.2	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	38.4 W Pdiss, CW	168	°C
Median Lifetime ( $T_M$ )		7.0E8	Hrs
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	2.4	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	57.6 W Pdiss, CW	222	°C
Median Lifetime ( $T_M$ )		7.0E6	Hrs
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	2.6	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	76.8 W Pdiss, CW	285	°C
Median Lifetime ( $T_M$ )		7.0E4	Hrs

**Thermal and Reliability Information - Pulsed**


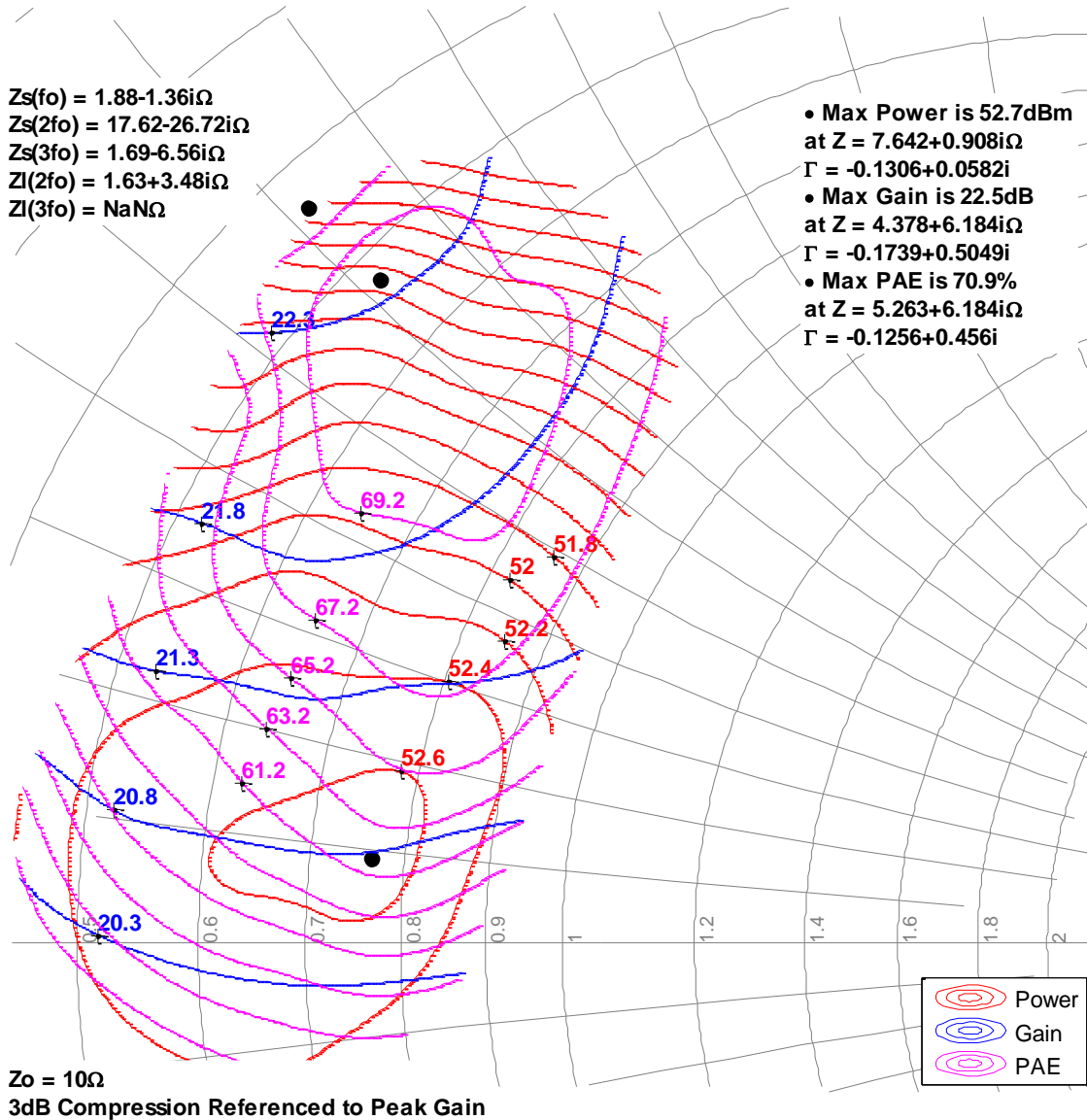
Parameter	Conditions	Values	Units
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	2.0	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	90 W Pdiss, Pulsed 100us 10% DC	200	°C
Median Lifetime ( $T_M$ )		4.0E8	Hrs
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	1.7	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	100 W Pdiss, Pulsed 100us 10% DC	215	°C
Median Lifetime ( $T_M$ )		1.0E8	Hrs
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	1.5	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	110 W Pdiss, Pulsed 100us 10% DC	232	°C
Median Lifetime ( $T_M$ )		3.0E7	Hrs
Thermal Resistance ( $\theta_{JC}$ )	85 °C Case	1.4	°C/W
Maximum Channel Temperature ( $T_{CH}$ )	120 W Pdiss, Pulsed 100us 10% DC	251	°C
Median Lifetime ( $T_M$ )		8.0E6	Hrs

**Load Pull Smith Charts<sup>1,2</sup>**

Notes:

1.  $V_d = 65\text{ V}$ ,  $I_{bQ} = 240\text{ mA}$ , Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

**1.2GHz, Load-pull**



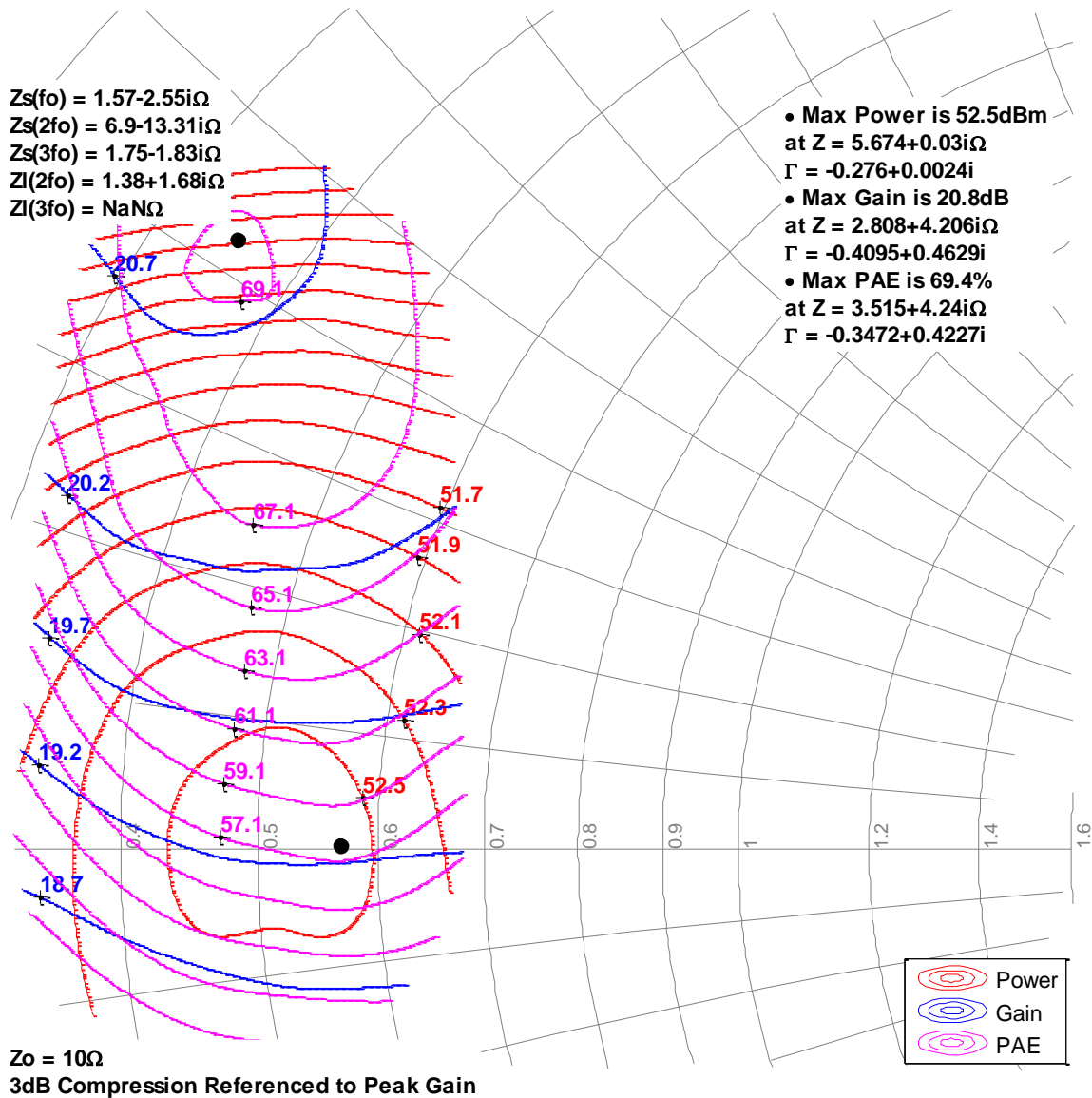


**Load Pull Smith Charts<sup>1,2</sup>**

Notes:

1.  $V_d = 65\text{ V}$ ,  $I_{BQ} = 240\text{ mA}$ , Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

**1.5GHz, Load-pull**

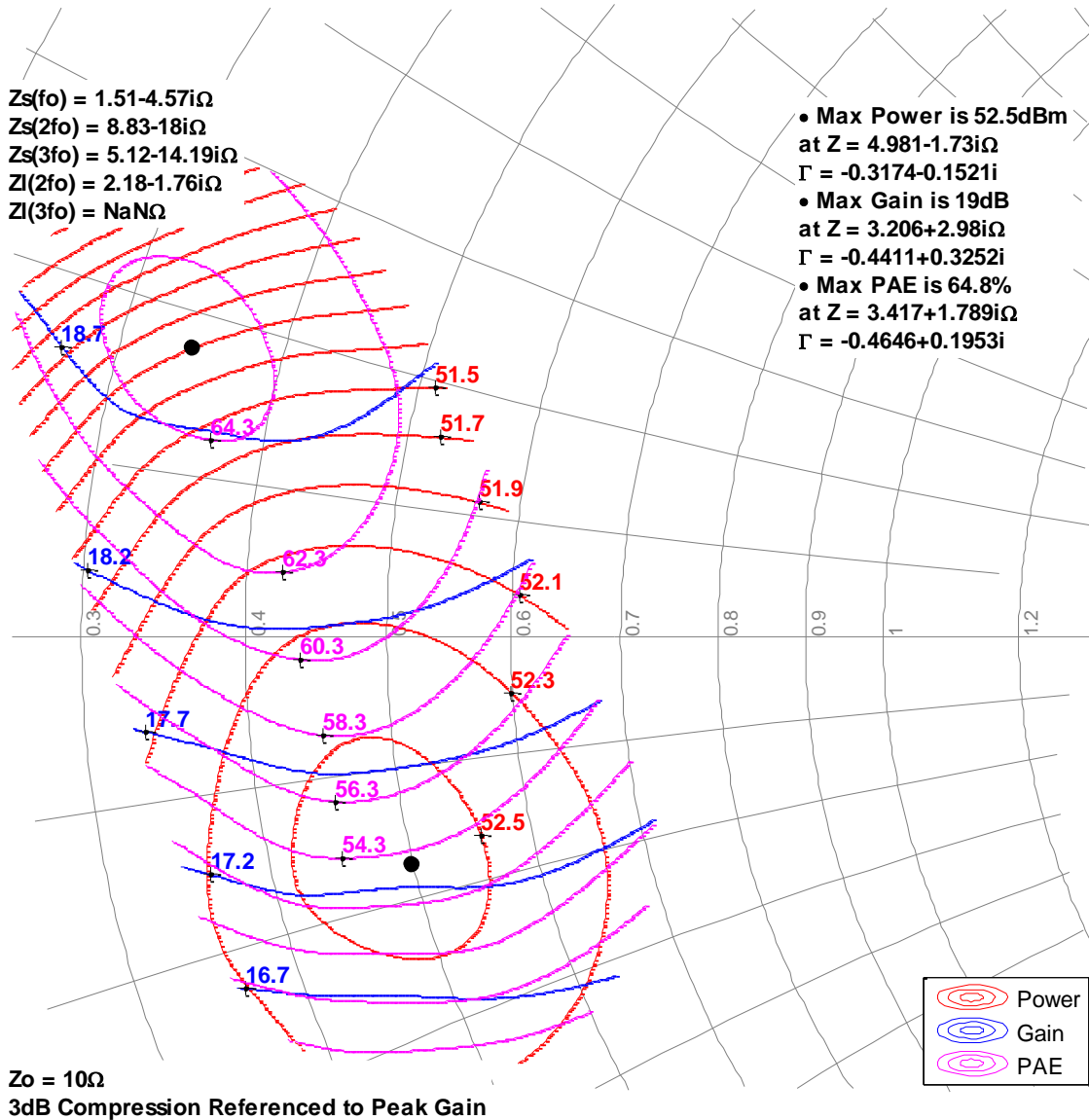


**Load Pull Smith Charts<sup>1,2</sup>**

Notes:

1.  $V_d = 65\text{ V}$ ,  $I_{BQ} = 240\text{ mA}$ , Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

**1.8GHz, Load-pull**

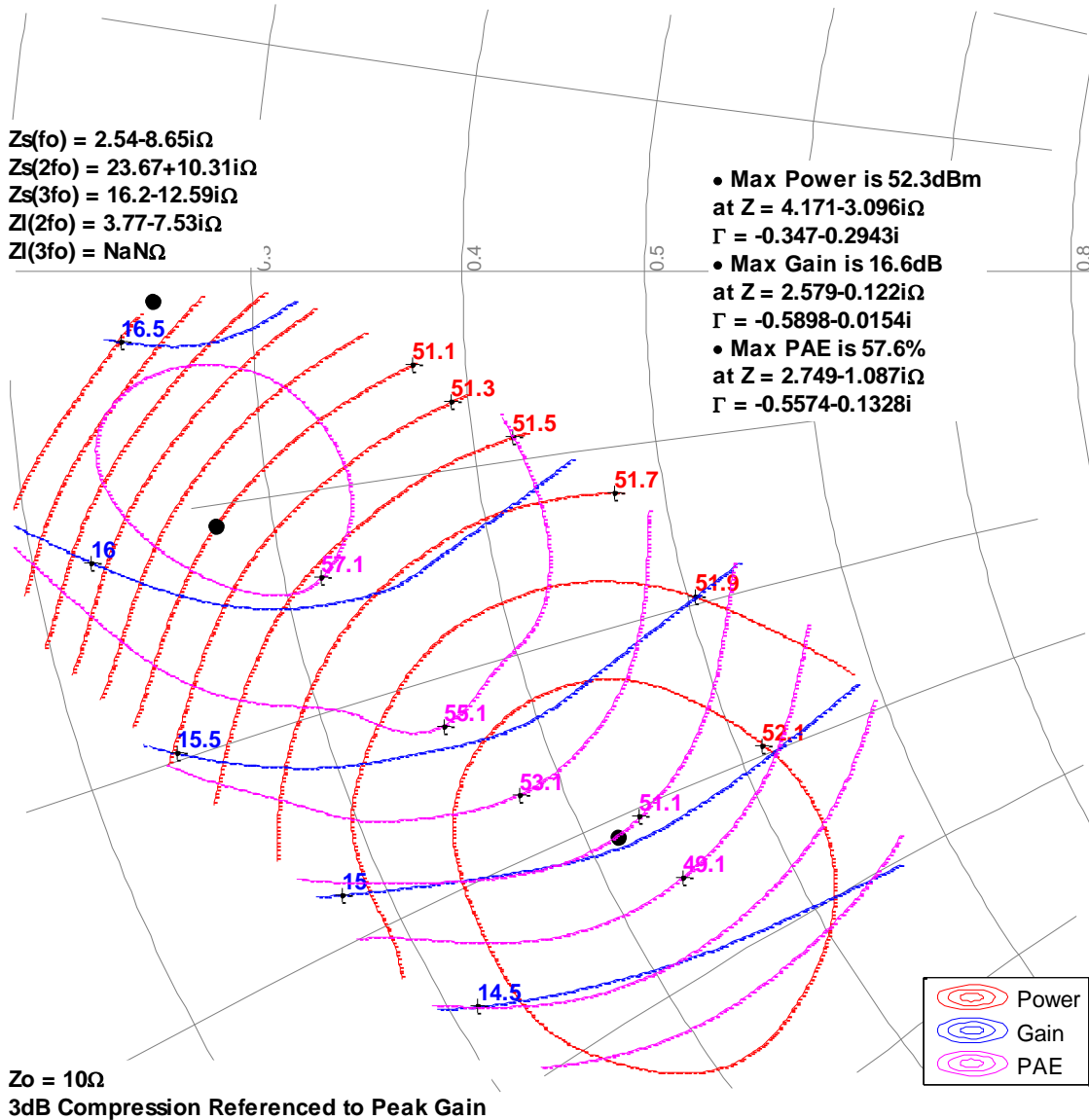


**Load Pull Smith Charts<sup>1,2</sup>**

Notes:

1.  $V_d = 65\text{ V}$ ,  $I_{BQ} = 240\text{ mA}$ , Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

**2.3GHz, Load-pull**

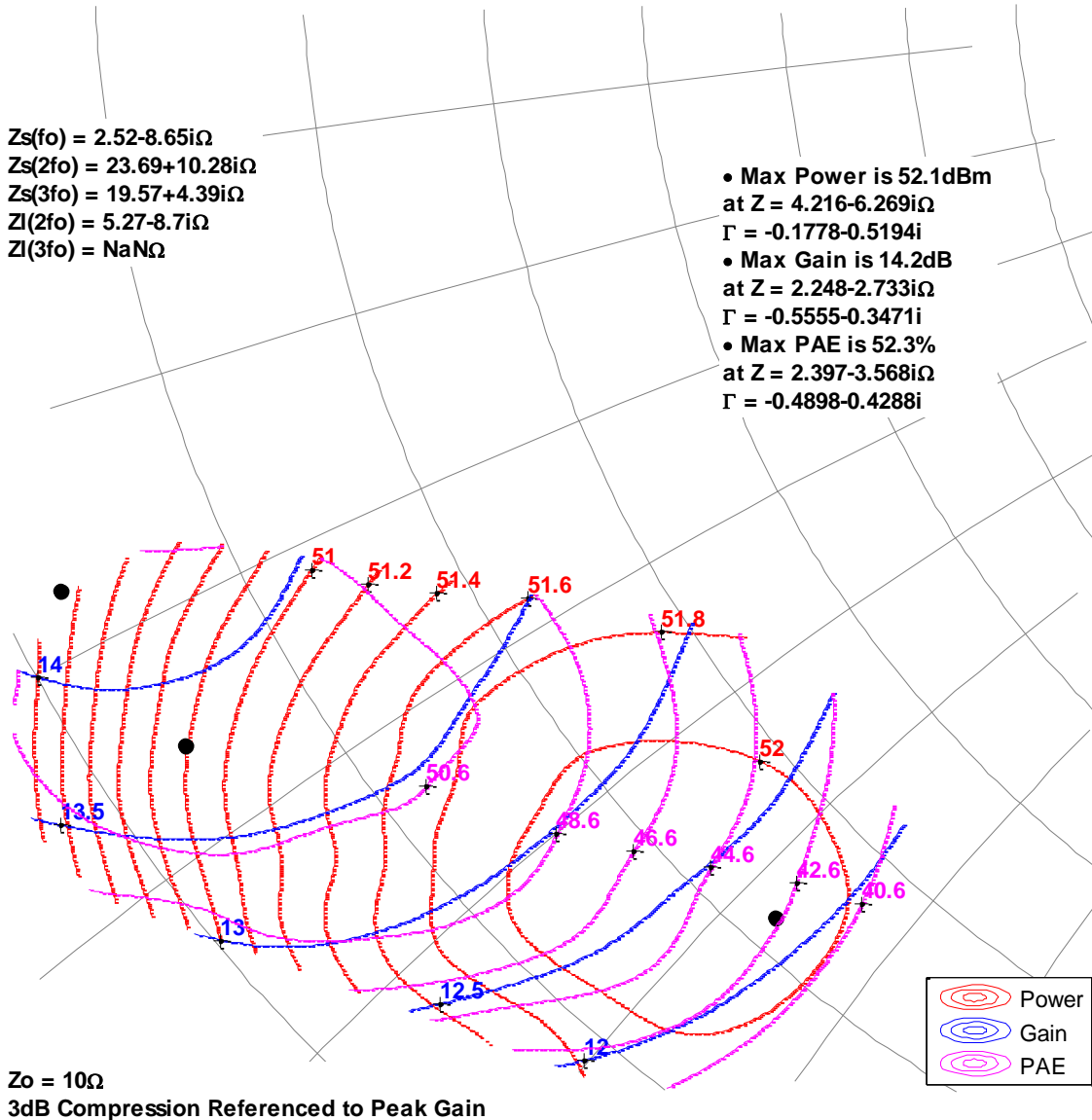


**Load Pull Smith Charts<sup>1,2</sup>**

Notes:

1.  $V_d = 65\text{ V}$ ,  $I_{DQ} = 240\text{ mA}$ , Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

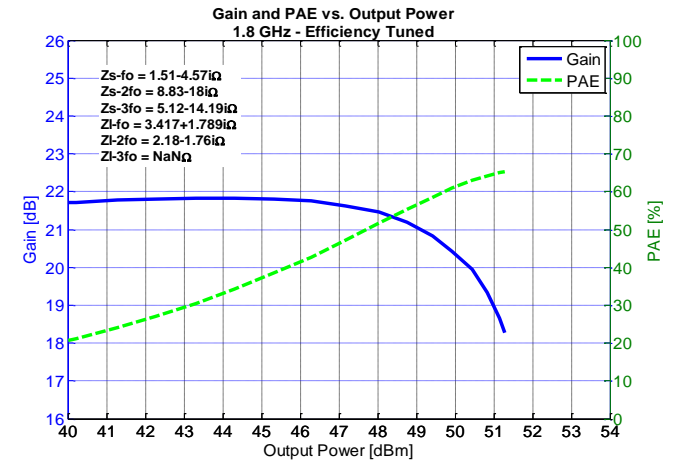
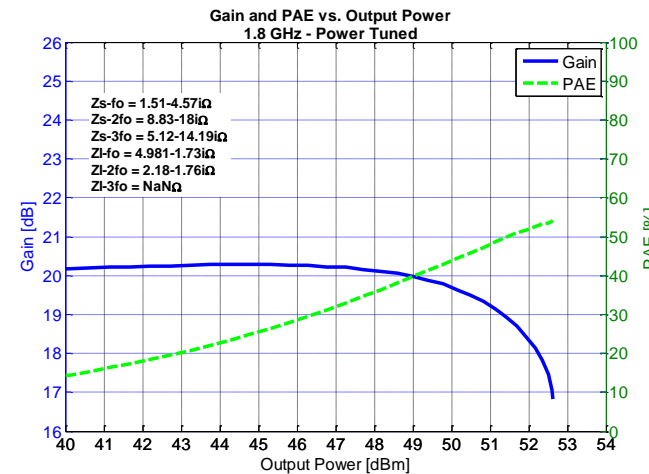
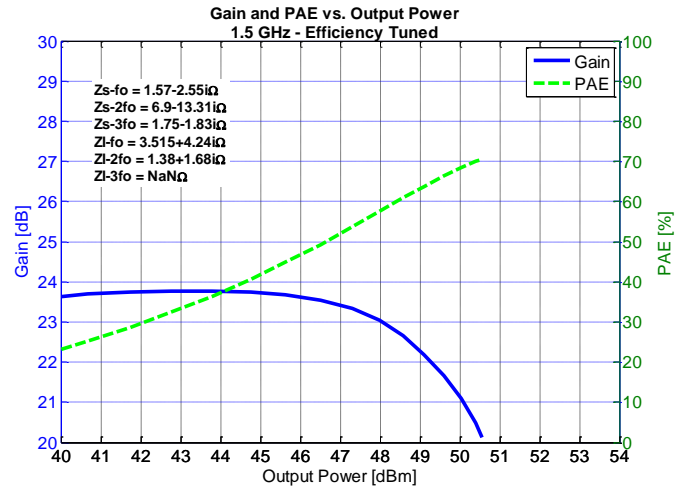
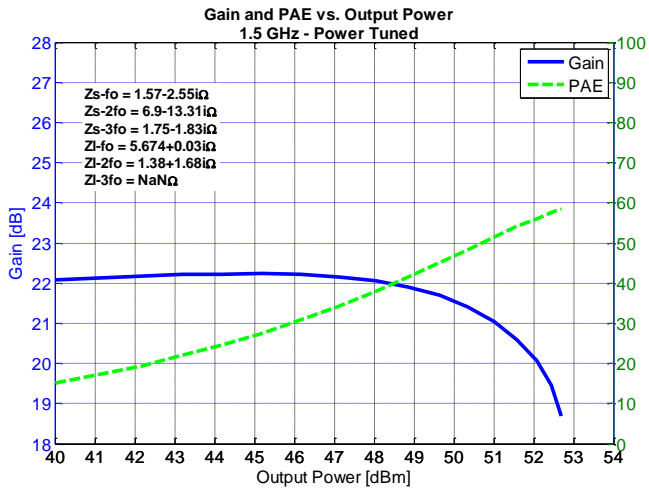
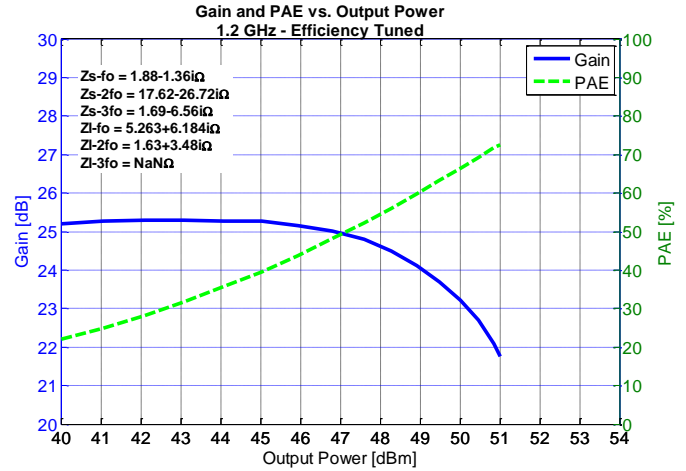
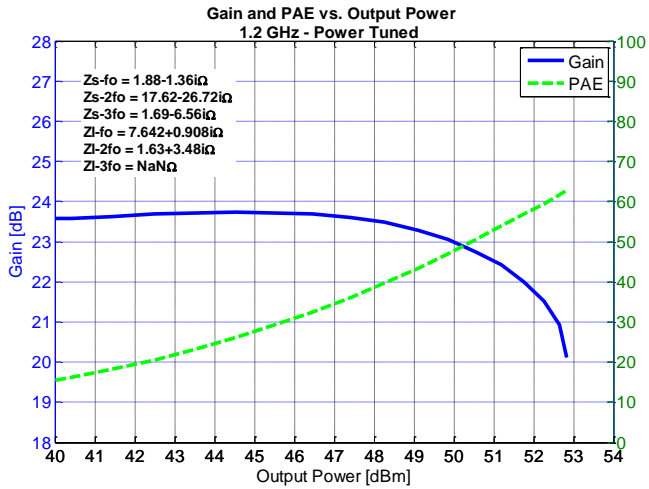
**2.7GHz, Load-pull**



### Typical Performance – Load Pull Drive-up

Notes:

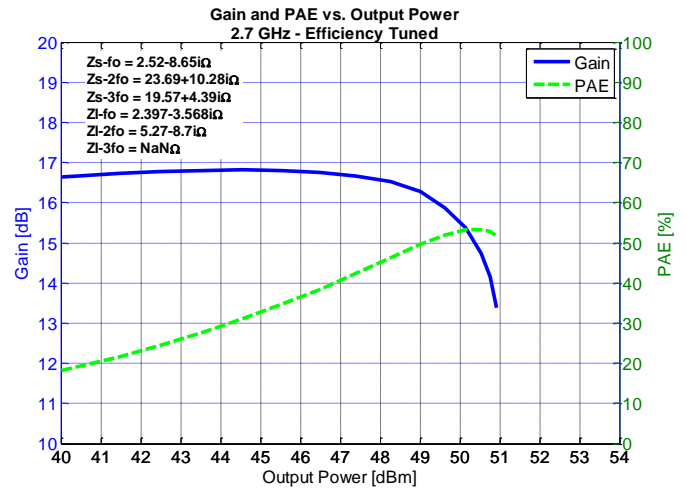
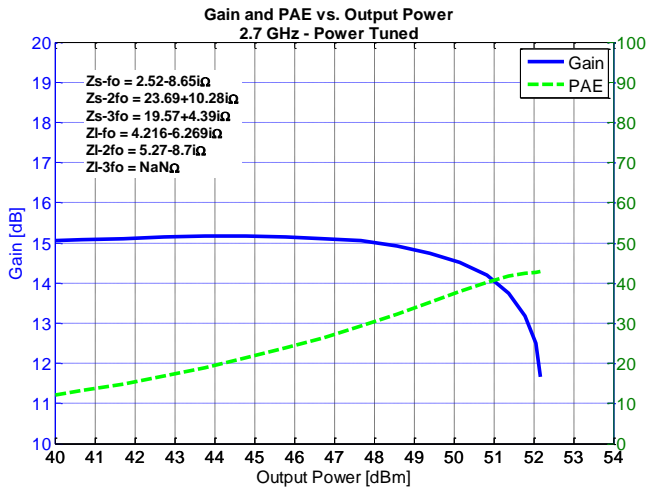
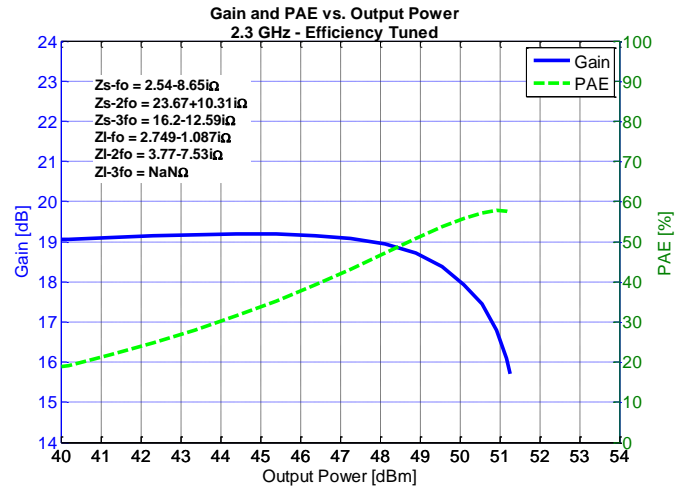
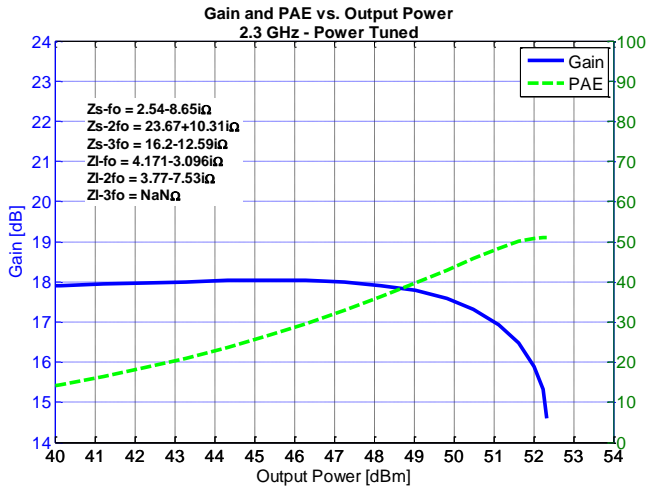
1. Pulsed signal with 100 us pulse width and 10 % duty cycle,  $V_d = 65\text{ V}$ ,  $I_{DQ} = 240\text{ mA}$
2. See page 20 for load pull and source pull reference planes where the performance was measured.



### Typical Performance – Load Pull Drive-up

Notes:

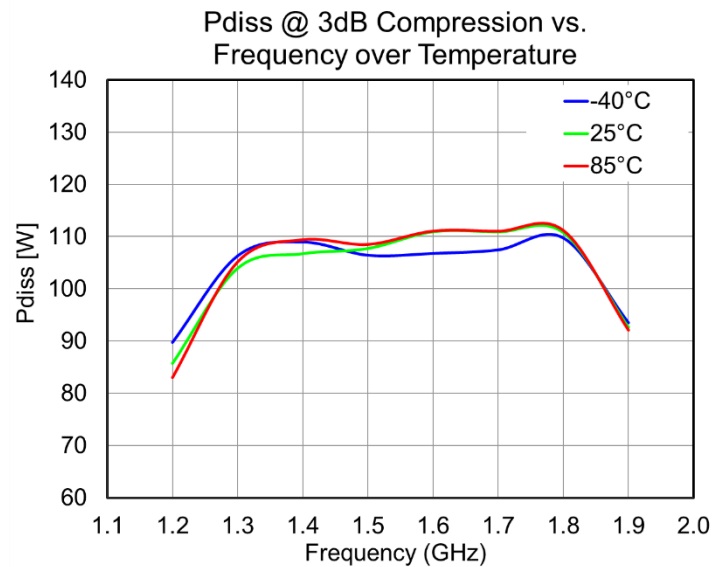
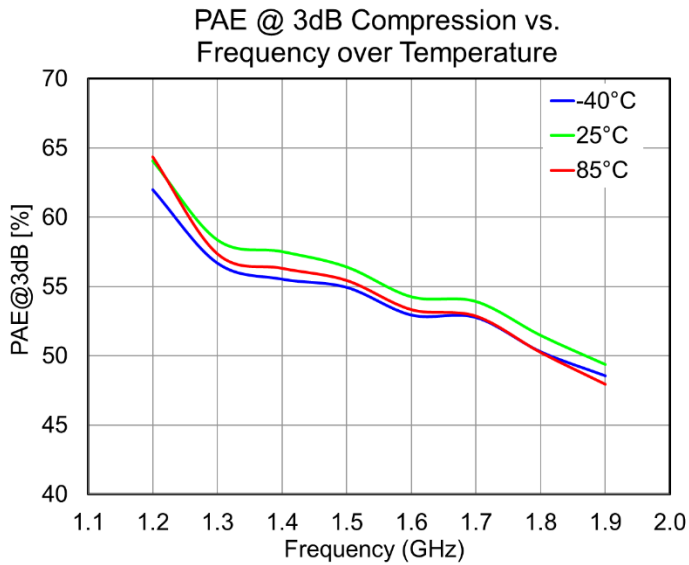
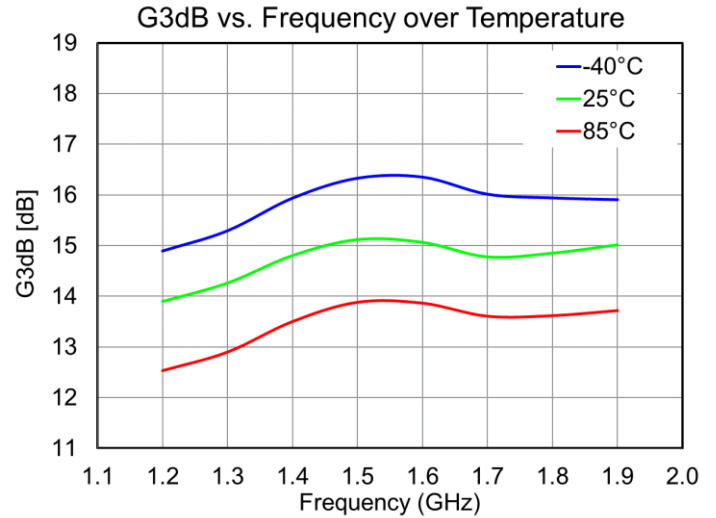
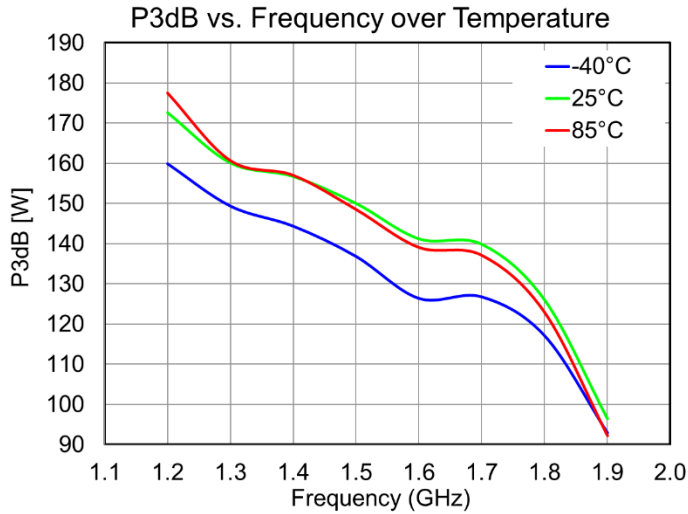
1. Pulsed signal with 100 us pulse width and 10 % duty cycle,  $V_d = 65\text{ V}$ ,  $I_{DQ} = 240\text{ mA}$
2. See page 20 for load pull and source pull reference planes where the performance was measured.



### Power Driveup Performance Over Temperatures of 1.2 – 1.9 GHz EVB – 65 V<sup>1</sup>

Notes:

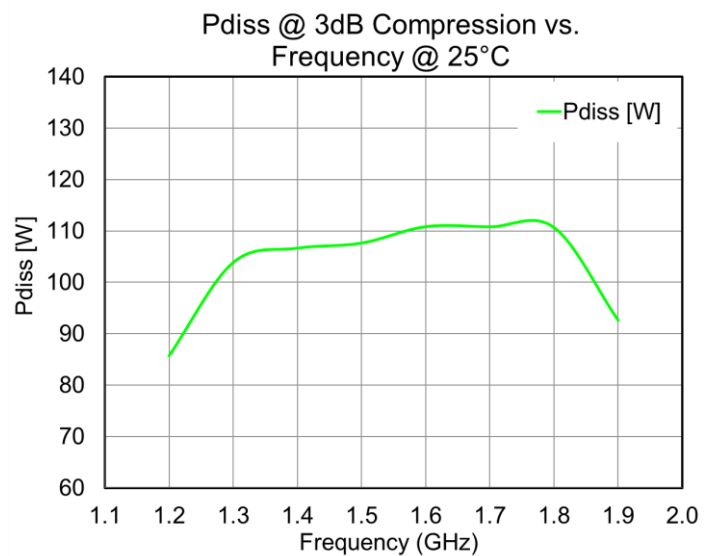
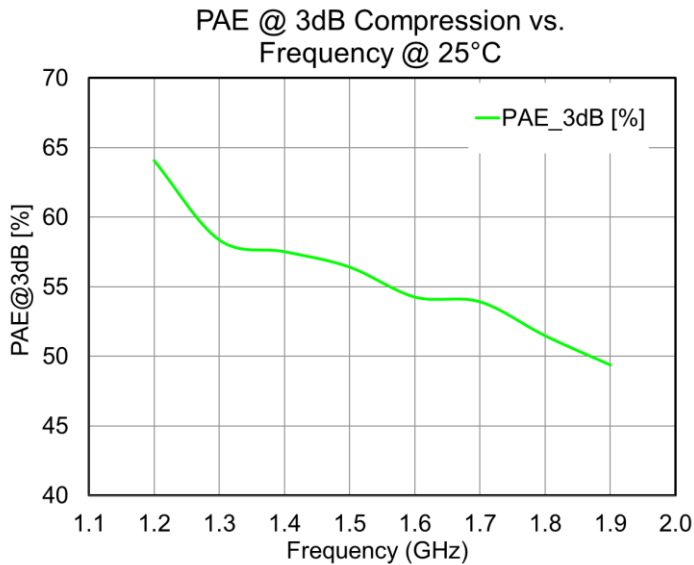
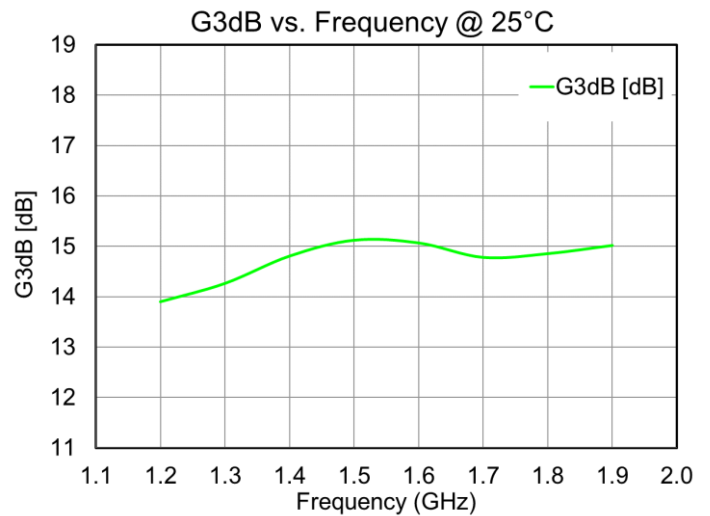
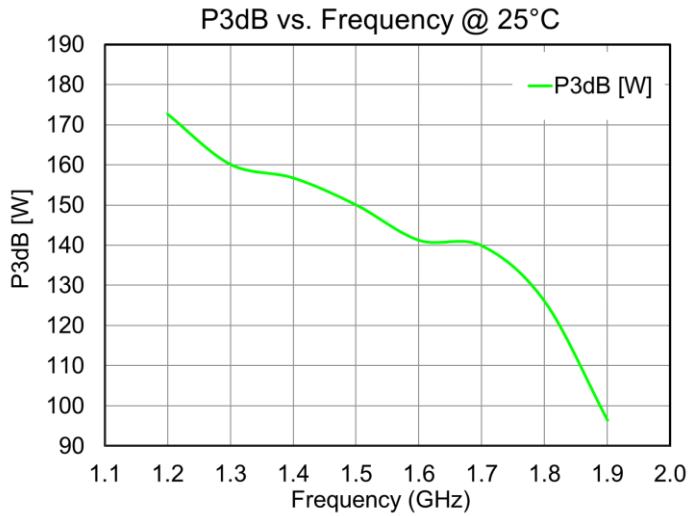
1-  $V_d = 65\text{ V}$ ,  $I_{DQ} = 240\text{ mA}$ , Pulse Width = 100  $\mu\text{s}$ , Duty Cycle = 10 %



### Power Driveup Performance at 25 °C of 1.2 – 1.9 GHz EVB – 65 V<sup>1</sup>

Notes:

1-  $V_d = 65\text{ V}$ ,  $I_{BQ} = 240\text{ mA}$ , Pulse Width = 100  $\mu\text{s}$ , Duty Cycle = 10 %

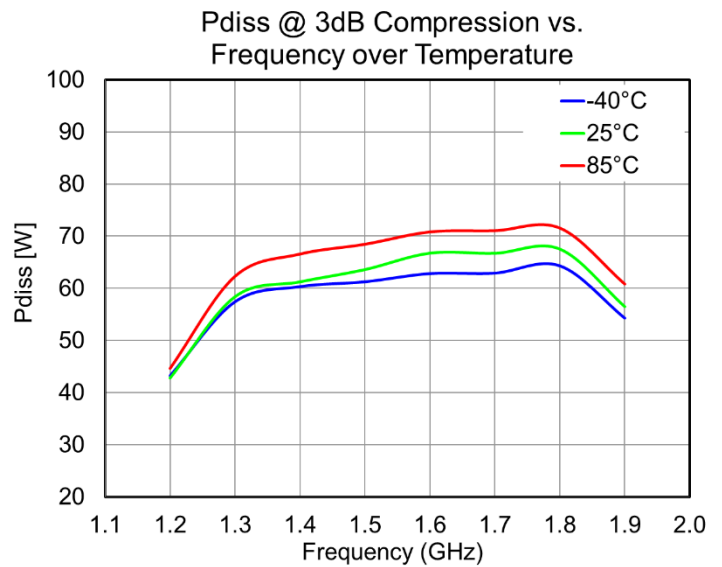
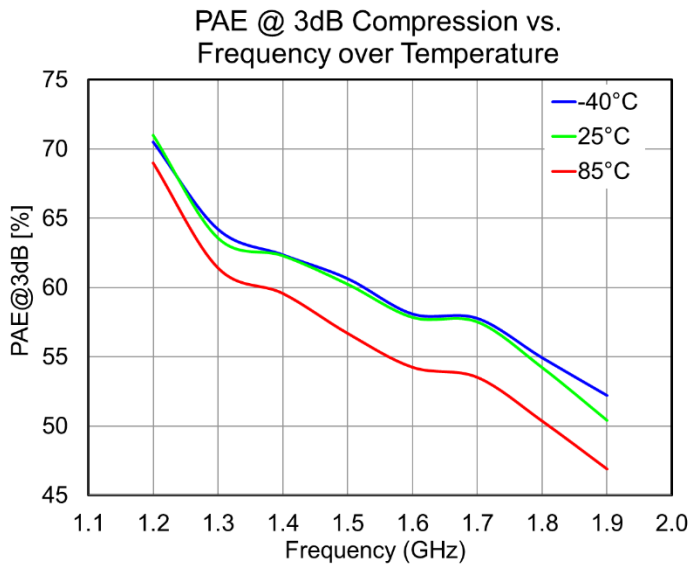
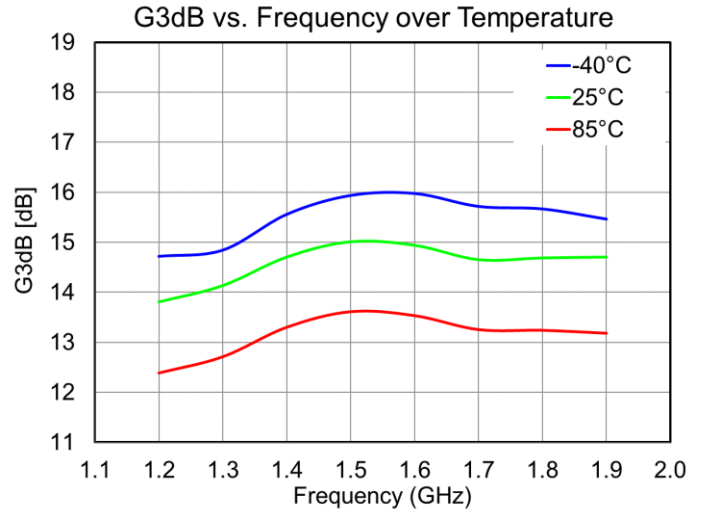
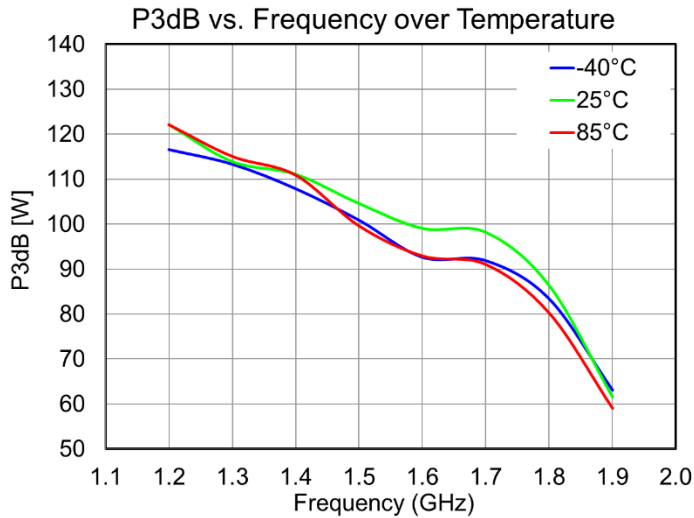




### Power Driveup Performance Over Temperatures of 1.2 – 1.9 GHz EVB – 50 V<sup>1</sup>

Notes:

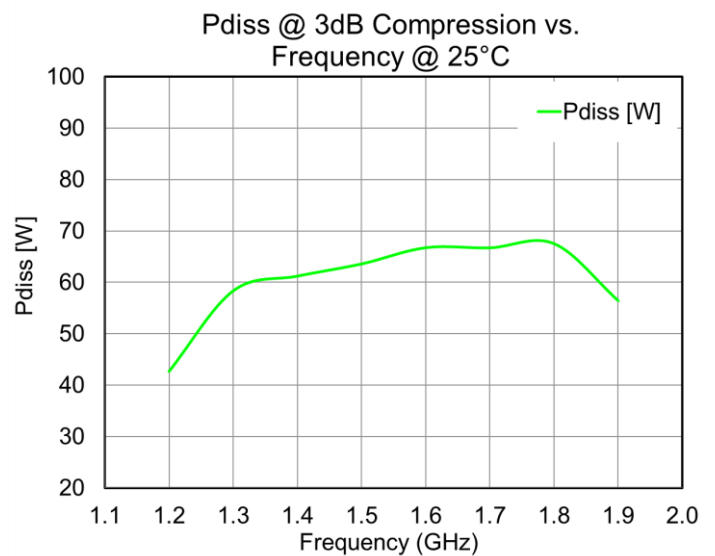
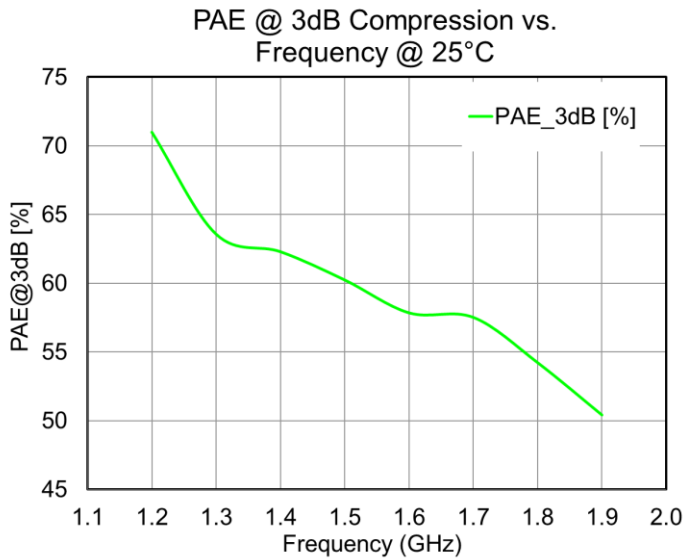
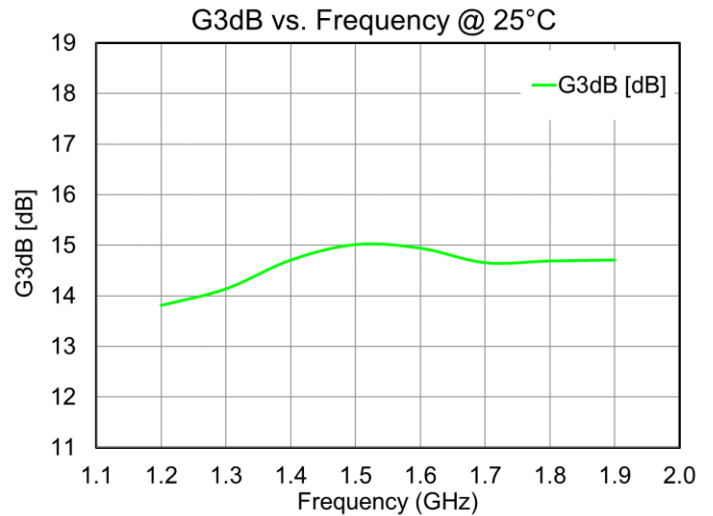
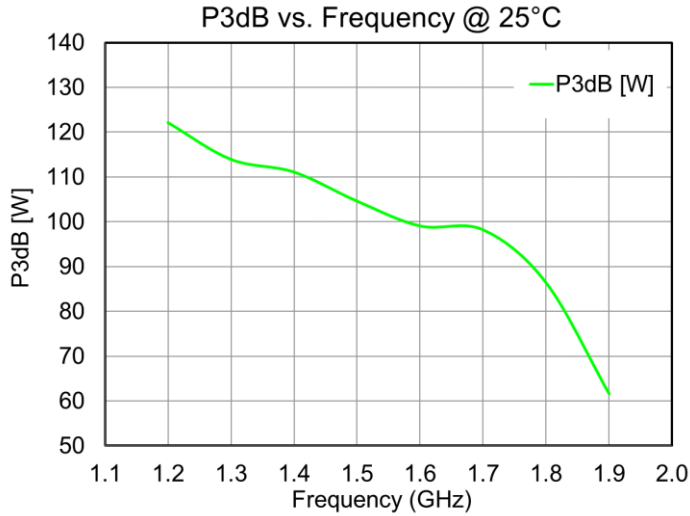
1-  $V_d = 50\text{ V}$ ,  $I_{BQ} = 240\text{ mA}$ , Pulse Width = 100  $\mu\text{s}$ , Duty Cycle = 10 %



### Power Driveup Performance at 25 °C of 1.2 – 1.9 GHz EVB – 50 V<sup>1</sup>

Notes:

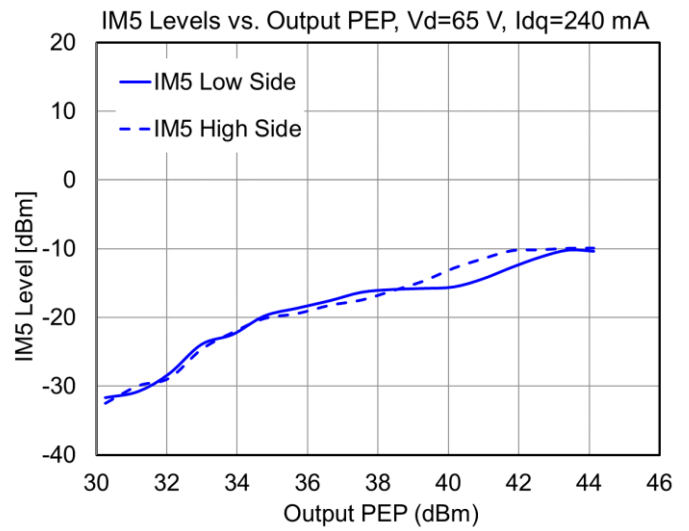
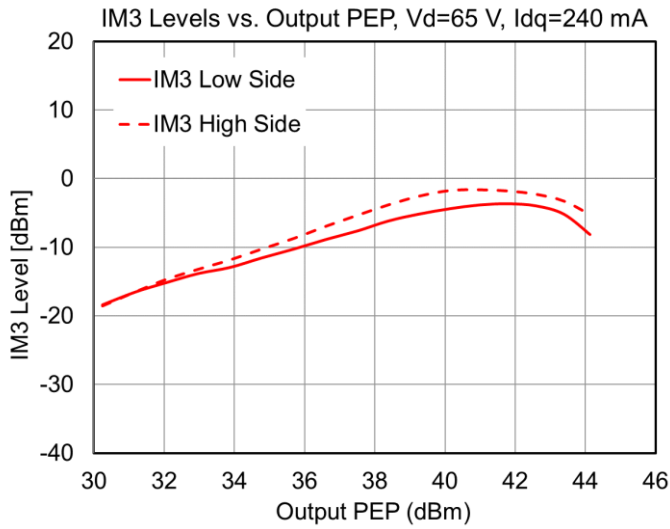
1-  $V_d = 50\text{ V}$ ,  $I_{BQ} = 240\text{ mA}$ , Pulse Width = 100 us, Duty Cycle = 10 %



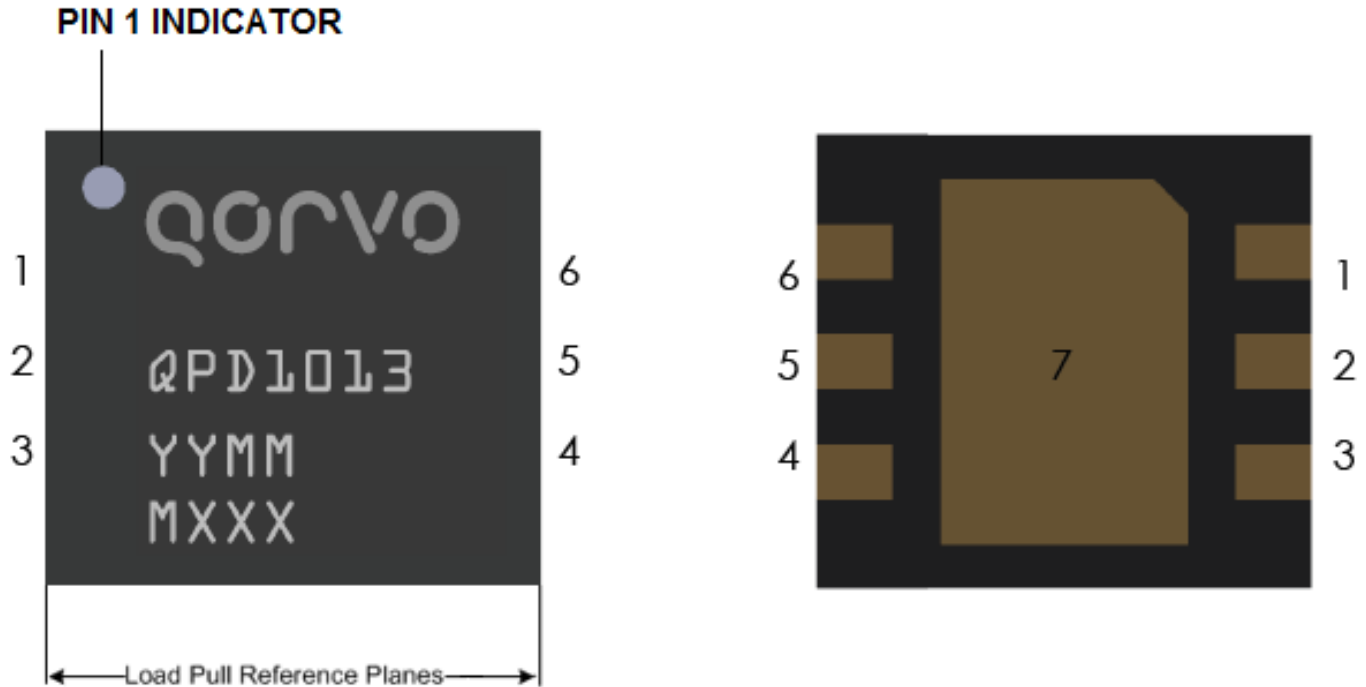
## Two-Tone Performance at 25 °C of 1.2 – 1.9 GHz EVB<sup>1</sup>

Notes:

- 1- Center Frequency = 1.5 GHz. Tone Separation = 1 MHz.



## Pin Layout <sup>1</sup>



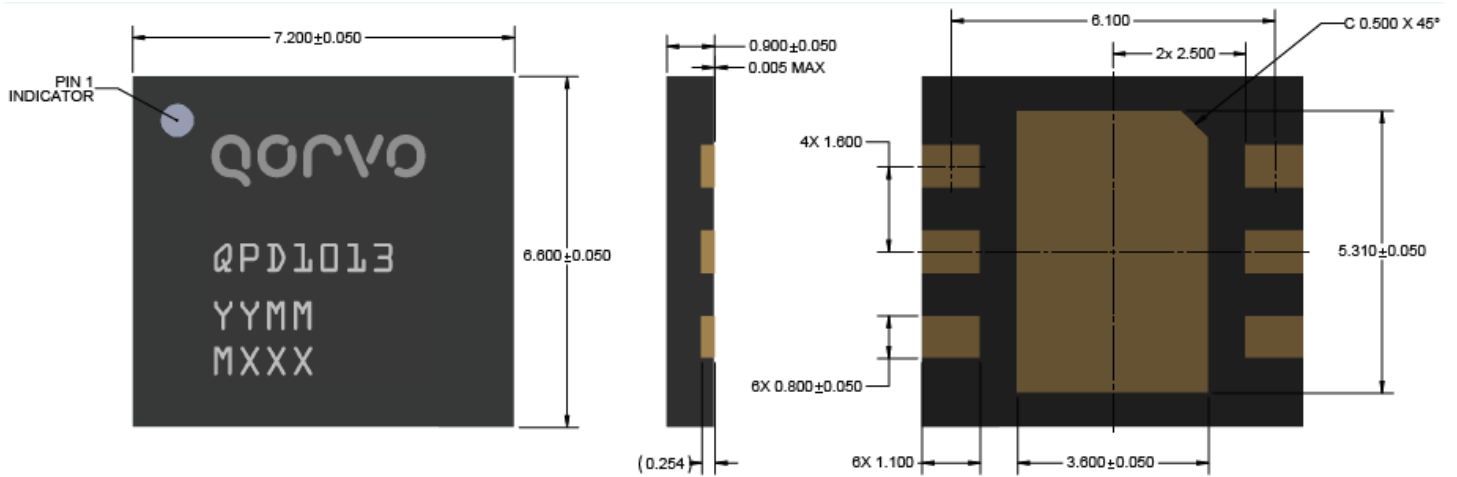
**Notes:**

- The QPD1013 will be marked with the “QPD1013” designator and a lot code marked below the part designator. The “YY” represents the last two digits of the calendar year the part was manufactured, the “MM” is the work week of the assembly lot start, the “MXXX” is the batch ID.

## Pin Description

Pin	Symbol	Description
1 – 3	VG / RF IN	Gate voltage / RF Input
4 – 6	VD / RF OUT	Drain voltage / RF Output
7	Back Plane	Source to be connected to ground

### Mechanical Drawing



**Notes:**

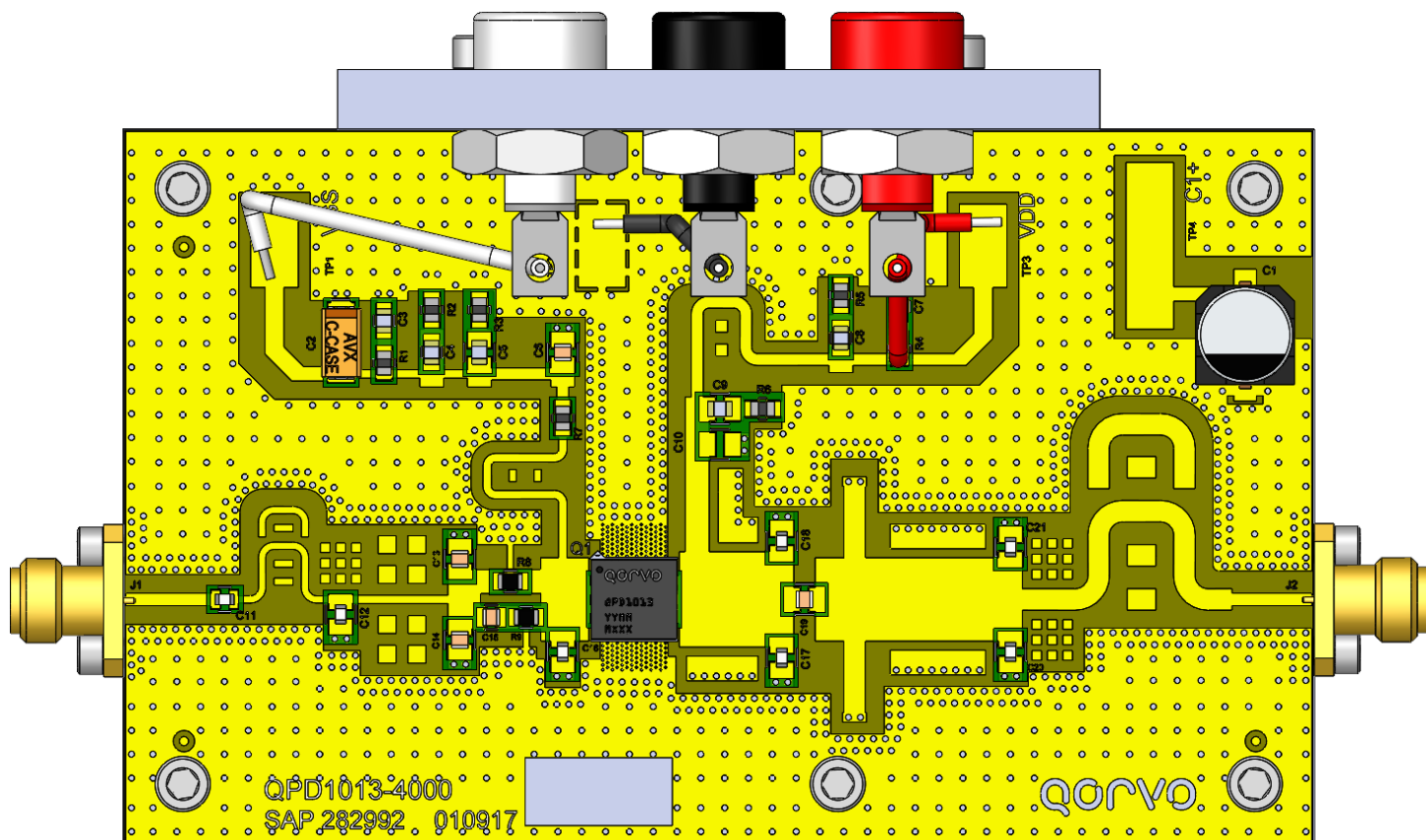
- 1- All dimensions are in mm, otherwise noted. Tolerance is  $\pm 0.050$  mm.

Bias-up Procedure	Bias-down Procedure
1. Set $V_G$ to -4 V.	1. Turn off RF signal.
2. Set ID current limit to 500 mA.	2. Turn off VD
3. Apply 65 V VD.	3. Wait 2 seconds to allow drain capacitor to discharge
4. Slowly adjust VG until ID is set to 240 mA.	4. Turn off VG
5. Set ID current limit to 3 A	
6. Apply RF.	

PCB Layout – 1.2 – 1.9 GHz EVB<sup>1</sup>

Notes:

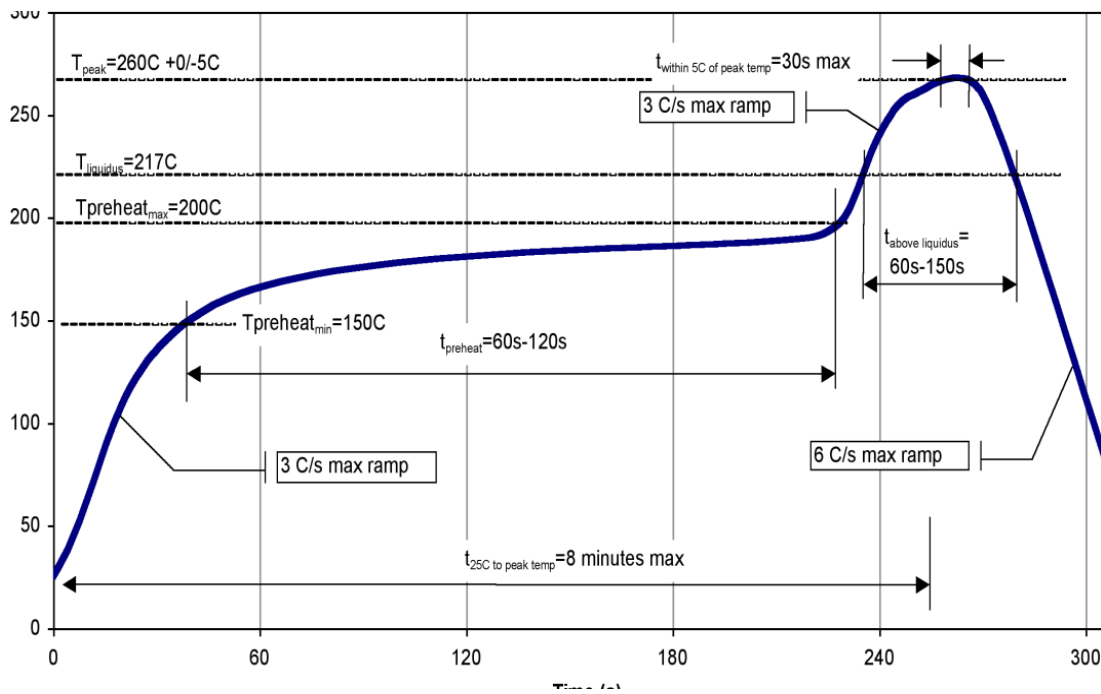
- 1- PCB Material is RO4350B, 20 mil thick substrate, 1 oz. copper each side.



**Bill Of material – 1.2 – 1.9 GHz EVB**

Ref Des	Value	Description	Manufacturer	Part Number
C4, C8	1.0 nF	X7R 100V 5% 0805 Capacitor	AVX	08051C102JAT2A
C3, C7	10.0 nF	X7R 100V 5% 0805 Capacitor	AVX	08051C103JAT2A
C20 – C21	1.5 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S1R5BT250XT
C13 – C14	1.2 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC800A1R2BT250XT
C12	2.0 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S2R0BT250XT
C16	3.6 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S3R6BT250XT
C17 – C18	3.9 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S3R9BT250XT
C11	4.7 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S4R7BT250XT
C15, C19	12.0 pF	RF C0G 250VDC 5% Capacitor	ATC	ATC800A120JT250XT
C6	22.0 pF	RF C0G 250VDC 5% Capacitor	ATC	ATC800A220JT250XT
C5, C9	100 pF	RF C0G 250VDC 5% Capacitor	ATC	ATC600F101JT250XT
C1	33 uF	80V 20% SVP Capacitor	Panasonic	EEEFK1K330P
C2	10 uF	16V 10% Tantalum Capacitor	AVX	TPSC106KR0500
J1 - 2	–	SMA Panel Mount 4-hole Jack	Gigalane	PSF-S00-000
R7	3.0 Ohm	0805 1% Thick Film Resistor	ANY	–
R1 – R6	5.1 Ohm	0805 1% Thick Film Resistor	ANY	–
R8	3.0 Ohm	0805 16W 5% Thick Film Resistor	IMS	NGC-0805CS3R00J
R9	5.0 Ohm	0805 16W 5% Thick Film Resistor	IMS	NGC-0805CS5R00J

**Recommended Solder Temperature Profile**





## Product Compliance Information

---

### ESD Sensitivity Ratings



Caution! ESD Sensitive Device

### ESD Rating

ESD Rating: Class 1A  
Value: 450 V  
Test: Human Body Model (HBM)  
Standard: JEDEC Standard JESD22-A114

### MSL Rating

MSL Rating: TBD  
Test: 260 °C convection reflow  
Standard: JEDEC Standard IPC/JEDEC J-STD-020

### Solderability

Compatible with lead free soldering processes, 260 °C maximum reflow temperature.

Package lead plating: NiAu

The use of no-clean solder to avoid washing after soldering is recommended.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free
- SVHC Free

## Contact Information

---

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about Qorvo:

Web: [www.Qorvo.com](http://www.Qorvo.com)  
Email: [info-sales@qorvo.com](mailto:info-sales@qorvo.com)

Tel: +1.972.994.8465  
Fax: +1.972.994.8504

For technical questions and application information: Email: [info-products@qorvo.com](mailto:info-products@qorvo.com)

## Important Notice

---

The information contained herein is believed to be reliable. Qorvo makes no warranties regarding the information contained herein. Qorvo assumes no responsibility or liability whatsoever for any of the information contained herein. Qorvo assumes no responsibility or liability whatsoever for the use of the information contained herein. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the user. All information contained herein is subject to change without notice. Customers should obtain and verify the latest relevant information before placing orders for Qorvo products. The information contained herein or any use of such information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights, whether with regard to such information itself or anything described by such information.

Qorvo products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [RF JFET Transistors](#) category:*

*Click to view products by [Qorvo](#) manufacturer:*

Other Similar products are found below :

[CE3514M4](#) [CE3514M4-C2](#) [CE3520K3-C1](#) [CE3521M4](#) [CE3521M4-C2](#) [CE3512K2-C1](#) [CE3520K3](#) [CG2H80030D-GP4](#) [TGF2023-2-02](#)  
[NPT1004D](#) [MAGX-011086](#) [NPT25015D](#) [JANTXV2N4858](#) [MMBFJ211](#) [NPT2021](#) [NPTB00025B](#) [2SK3557-6-TB-E](#) [J211\\_D74Z](#)  
[NPTB00004A](#) [QPD0020](#) [QPD1006](#) [QPD1016](#) [QPD1025L](#) [QPD1029L](#) [QPD1881L](#) [T2G6001528-Q3](#) [SKY65050-372LF](#) [TGF2965-SM](#)  
[QPD1009](#) [QPD1010](#) [J304](#) [CGH27015F](#) [CGH55015F1](#) [CMPA801B030F](#) [GTVA262711FA-V2-R0](#) [GTVA262701FA-V2-R0](#) [CGH40006S](#)  
[CGH40010F](#) [CGH40025F](#) [CGH40045F](#) [CGH40120F](#) [CGH55015F2](#) [CGH60008D](#) [CGH60030D](#) [CGHV14500F](#) [CGHV1F006S](#)  
[CGHV1J006D](#) [CGHV27030S](#) [CGHV27060MP](#) [CGHV40030F](#)